

NGW75T60H3DF-VB Datasheet 600V Trench and Fieldstop IGBT

PRODUCT SUMMA	RY			
V _{CE} (V)	600)		
I _C (A)	90 (TC=25)	75 (TC=100)		
VCE (sat) (V)	1.	7		
Q _g (nC)	175			
Ісм (А)	22	5		

FEATURES

- Very Low VCEsat
- · Low turn-off losses
- High speed switching
- Maximum junction temperature 175°C
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)



APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switch mode power supplies (SMPS)

Package pin definition

- Pin1 G Gate
- Pin2 C & backside Collector
- Pin3 E Emitter

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ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Collector-Emitter Voltage			V _{CE}	600	V
Gate-Emitter Voltage			V_{GE}	±30	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Continuous Collector Current /T 150 °C)	\/ at 15 \/	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		150	
Continuous Collector Current (T _J = 150 °C)	V _{GE} at 15 V	T _C = 100 °C	I _C	75	Α
Pulsed Collector Current ^a			I _{CM}	225	
Diode Forward Current b			l _F	90	А
Maximum Power Dissipation		T _C = 25 °C	P _D	400	W
Waxiinum i Ower Dissipation	$T_{\rm C} = 100 ^{\circ}{\rm C}$ 220		220	W	
Operating Junction and Storage Temperature Range	е		T _J , T _{stg}	-55 to +175	°C
Short Circuit Withstand Time TC=150	VGE= 15V, VCE 400V		3		
Short Circuit Withstand Time TC=100	VGE= 15V, V	CE 330V	tsc	5	μs
Soldering Recommendations (Peak Temperature) c	for	10 s		260	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. Current limited by maximum junction temperature.
- c. 1.6 mm from case.

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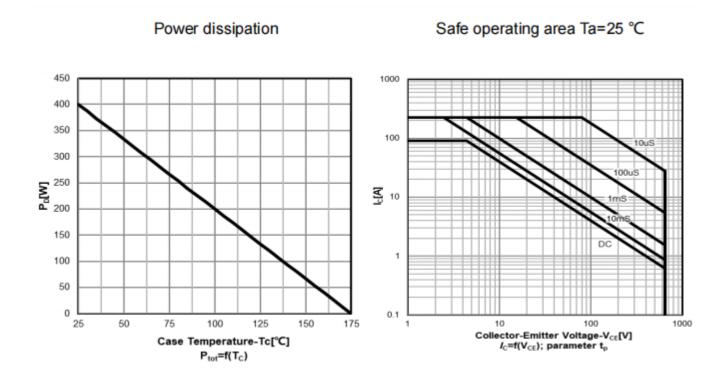


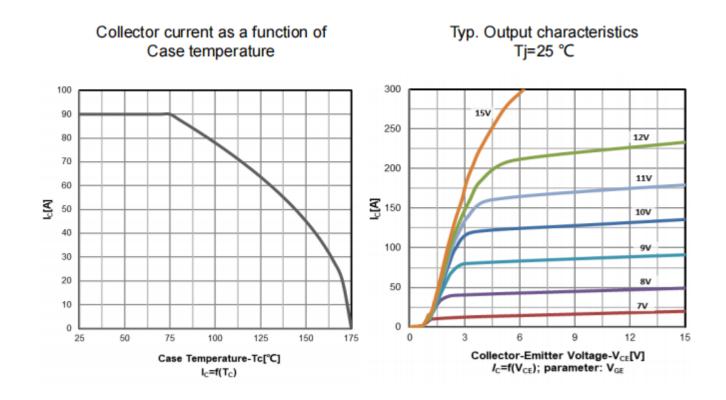
THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W
Maximum Junction-to-Case	R _{thJC}	-	0.5	C/ VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				l			
	DV	V _{GE} :	= 0 V, I _C = 250 μA	600	-	-	V
Collector-Emitter Breakdown Voltage	BV _{CE}	Vge	= 0 V, Ic = 1 mA	600	-	-	V
Gate-Source Threshold Voltage (N)	V _{GE(th)}	V _{CE} =	= V _{GE} , I _D = 250 μA	4	5	6	V
Zero Gate Voltage Collector Current		V _{CE} =480 V,	/GE = 0 V,TJ = 25 °C	-	1	20	μΑ
Zero Gate Voltage Collector Current	I _{CES}	VCE = 480 V,	VGE = 0 V,TJ = 150 °C	-	1000	-	μΑ
Gate-Emitter Leakage Current	I _{GES}	V _{CE} = 0	V , $V_{GS} = \pm 2 0 V$	-	-	100	nA
Collector-Emitter Saturation Voltage	V _{CE(sat)}	V _{GE} = 15 V	I _C = 75 A	-	1.7	2.1	V
Forward Transconductance	9 _{fs}		= 20 V, I _C = 75 A	-	40	-	S
Dynamic					•	•	
Input Capacitance	C _{ies}	V	= 0 V, Vce = 25 V,		4600	-	pF
Output Capacitance	Coes	Ţ VGE	f = 500 KHz	-	235	-	
Reverse Transfer Capacitance	C _{res}	1 = 500 KHZ		-	72	-	1
Turn-on Energy	E _{on}	$V_{CE} = 400 \text{ V}$, $V_{GE} = 0 / 15 \text{V}$,		-	0.62	-	ns
Turn-off Energy	Eoff	$I_C = 75 \text{ A}, R_g = 10\Omega$		_	0.31	-	113
Total Gate Charge	Q_g			-	175	-	
Gate-Emitter Charge	Q _{ge}	V _{GE} = 15 V	$I_C = 75 \text{ A}, V_{CE} = 400 \text{ V}$	-	14	-	nC
Gate to Collector Charge	Q _{gc}			-	33	-	
Turn-On Delay Time	t _{d(on)}		400 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	-	60	-	
Rise Time	t _r	V _{CE}	$= 400 \text{ V}$, $V_{GE} = 0 / 15 \text{V}$,	-	43	-] nc
Turn-Off Delay Time	t _{d(off)}	$I_{C} = 75 \text{ A}, R_{g} = 10\Omega$		-	184	-	ns
Fall Time	t _f		= 7071, Fig = 1022	-	30	-	
Internal emitter inductance measured 5 mm	LE			-	13	-	nH
Diode Characteristics							
Diode Forward Current	Ι _Ε	IGBT symbol showing the integral reverse junction diode		-	-	75	
Pulsed Diode Forward Current	I _{FM}	- integral re	verse juniction aloue	-	-	225	_ A
Diode Forward Voltage	V _F		I _F = 30 A	-	1.65	2.0	V
Reverse Recovery Time	t _{rr}			-	73	-	ns
Reverse Recovery Charge	Q _{rr}		$I_J = 25 ^{\circ}\text{C}, I_F = 30 \text{A},$	-	85	-	μC
Reverse Recovery Current	I _{RRM}	dlf/dt = 200 A/ μ s, V _R = 400 V		-	13	-	A



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





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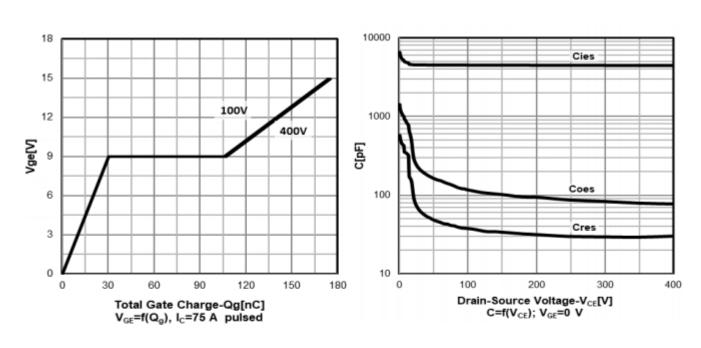
Typ. Output characteristics Typ. Transfer characteristics Tj=150 ℃ 300 300 15V 250 250 12V 200 200 Tj=25°C 11V **2** 150 **₹** 150 Tj=150°C 10V 100 100 8V 50 50 7V 0 0 15 12 14 Collector-Emitter Voltage- $V_{CE}[V]$ Gate-Emitter Voltage-V_{GE}[V] $I_C=f(V_{CE})$; parameter: V_{GE} $I_C=f(V_{GE}); V_{CE}=20V$

Typ. Collector-emitter saturation Normalized V_{GE(th)} vs. temperature voltage as a function of junction temperature (VGE=15V) 3.4 3 1.2 2.6 100A Normalized Vth 2.2 Acesat[V] 75A 504 1.4 0.6 0.6 25 -20 75 100 175 -60 Junction Temperature-Tj[°C] Junction Temperature-Tj[°C] $V_{GE(th)}=f(T_j);$ $V_{CE(SAT)}=f(T_j)$; parameter: I_C

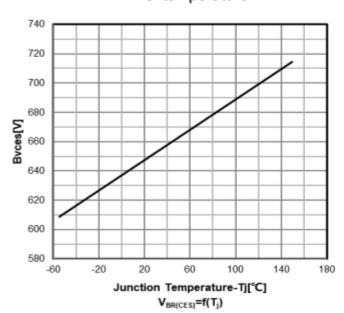


Gate charge characteristics

Capacitance characteristics



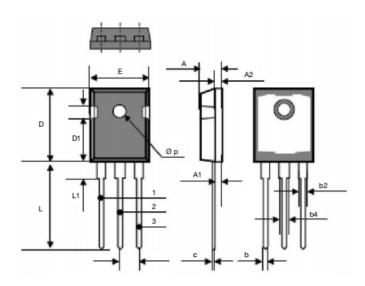
Collector-emitter breakdown voltage vs. temperature



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DIM.	MILL	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.70	5.31	0.185	0.209
A1	2.21	2.59	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	0.99	1.40	0.039	0.055
b2	1.65	2.41	0.065	0.095
b4	2.59	3.43	0.102	0.135
С	0.6	1 BSC	0.024 BSC	
D	20.80	21.46	0.819	0.845
D1	3.68	5.49	0.145	0.216
(e)	5.4	6 BSC	0.215	BSC
E	15.49	16.26	0.610	0.640
L	19.81	20.32	0.780	0.800
L1	4.06	4.50	0.160	0.177
Øp	3.51	3.66	0.138	0.144



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